



Intel® Core™ i7-6700 Processor

8M Cache, up to 4.00 GHz

[Export specifications](#)

Essentials

Product Collection	6th Generation Intel® Core™ i7 Processors
Code Name	Products formerly Skylake
Vertical Segment	Desktop
Processor Number	i7-6700
Status	Launched
Launch Date ?	Q3'15
Lithography ?	14 nm
Included Items	Thermal Solution - E97379
Recommended Customer Price ?	\$303.00 - \$312.00

Performance

# of Cores ?	4
# of Threads ?	8
Processor Base Frequency ?	3.40 GHz
Max Turbo Frequency ?	4.00 GHz
Cache ?	8 MB SmartCache
Bus Speed ?	8 GT/s DMI3
TDP ?	65 W

Supplemental Information

Embedded Options Available ?	Yes
Conflict Free ?	Yes
Datasheet	View now

Memory Specifications

Max Memory Size (dependent on memory type) ?	64 GB
Memory Types ?	DDR4-1866/2133, DDR3L-1333/1600 @ 1.35V
Max # of Memory Channels ?	2
Max Memory Bandwidth ?	34.1 GB/s
ECC Memory Supported [‡] ?	No

Graphics Specifications

Processor Graphics [‡] ?	Intel® HD Graphics 530
Graphics Base Frequency ?	350 MHz
Graphics Max Dynamic Frequency ?	1.15 GHz
Graphics Video Max Memory ?	64 GB
Graphics Output ?	eDP/DP/HDMI/DVI
4K Support ?	Yes, at 60Hz
Max Resolution (HDMI 1.4) [‡] ?	4096x2304@24Hz
Max Resolution (DP) [‡] ?	4096x2304@60Hz
Max Resolution (eDP - Integrated Flat Panel) [‡] ?	4096x2304@60Hz
Max Resolution (VGA) [‡] ?	N/A
DirectX* Support ?	12
OpenGL* Support ?	4.4
Intel® Quick Sync Video ?	Yes
Intel® InTru™ 3D Technology ?	Yes
Intel® Clear Video HD Technology ?	Yes
Intel® Clear Video Technology ?	Yes
# of Displays Supported [‡]	3

Device ID 0x1912

Expansion Options

Scalability	1S Only
PCI Express Revision ?	3.0
PCI Express Configurations [‡] ?	Up to 1x16, 2x8, 1x8+2x4

Max # of PCI Express Lanes [?](#) 16

Package Specifications

Sockets Supported [?](#) FCLGA1151

Max CPU Configuration 1

Thermal Solution Specification [?](#) PCG 2015C (65W)

T_{CASE} [?](#) 71°C

Package Size 37.5mm x 37.5mm

Low Halogen Options Available See MDDS

Advanced Technologies

Intel® Optane™ Memory Supported [‡] [?](#) No

Intel® Turbo Boost Technology [‡] [?](#) 2.0

Intel® vPro™ Technology [‡] [?](#) Yes

Intel® Hyper-Threading Technology [‡] [?](#) Yes

Intel® Virtualization Technology (VT-x) [‡] [?](#) Yes

Intel® Virtualization Technology for Directed I/O (VT-d) [‡] [?](#) Yes

Intel® VT-x with Extended Page Tables (EPT) [‡] [?](#) Yes

Intel® TSX-NI [?](#) Yes

Intel® 64 [‡] [?](#) Yes

Instruction Set [?](#) 64-bit

Instruction Set Extensions [?](#) SSE4.1/4.2, AVX2

Idle States [?](#) Yes

Enhanced Intel SpeedStep® Technology [?](#) Yes

Thermal Monitoring Technologies [?](#) Yes

Intel® Identity Protection Technology [‡] [?](#) Yes

Intel® Stable Image Platform Program (SIPP) [?](#) Yes

Security & Reliability

Intel® AES New Instructions [?](#) Yes

Secure Key [?](#) Yes

Intel® Software Guard Extensions (Intel® SGX) [?](#) Yes

Specifications

Essentials

Performance

Supplemental Information

Memory Specifications

Graphics Specifications

Expansion Options

Package Specifications

Advanced Technologies

Security & Reliability

Ordering and Compliance

Benchmarks

Compatible Products

Downloads and Software

Intel® Memory Protection Extensions (Intel® MPX) ?	Yes
Intel® OS Guard	Yes
Intel® Trusted Execution Technology ‡ ?	Yes
Execute Disable Bit ‡ ?	Yes
Intel® Boot Guard ?	Yes

All information provided is subject to change at any time, without notice. Intel may make changes to manufacturing life cycle, specifications, and product descriptions at any time, without notice. The information herein is provided "as-is" and Intel does not make any representations or warranties whatsoever regarding accuracy of the information, nor on the product features, availability, functionality, or compatibility of the products listed. Please contact system vendor for more information on specific products or systems.

Intel classifications are for informational purposes only and consist of Export Control Classification Numbers (ECCN) and Harmonized Tariff Schedule (HTS) numbers. Any use made of Intel classifications are without recourse to Intel and shall not be construed as a representation or warranty regarding the proper ECCN or HTS. Your company as an importer and/or exporter is responsible for determining the correct classification of your transaction.

Refer to Datasheet for formal definitions of product properties and features.

"Announced" SKUs are not yet available. Please refer to the Launch Date for market availability.

Some products can support AES New Instructions with a Processor Configuration update, in particular, i7-2630QM/i7-2635QM, i7-2670QM/i7-2675QM, i5-2430M/i5-2435M, i5-2410M/i5-2415M. Please contact OEM for the BIOS that includes the latest Processor configuration update.

‡ This feature may not be available on all computing systems. Please check with the system vendor to determine if your system delivers this feature, or reference the system specifications (motherboard, processor, chipset, power supply, HDD, graphics controller, memory, BIOS, drivers, virtual machine monitor-VMM, platform software, and/or operating system) for feature compatibility. Functionality, performance, and other benefits of this feature may vary depending on system configuration.

"Conflict free" and "conflict-free" means "DRC conflict free", which is defined by the U.S. Securities and Exchange Commission rules to mean products that do not contain conflict minerals (tin, tantalum, tungsten and/or gold) that directly or indirectly finance or benefit armed groups in the Democratic Republic of the Congo (DRC) or adjoining countries. Intel also uses the term "conflict-free" in a broader sense to refer to suppliers, supply chains, smelters and refiners whose sources of conflict minerals do not finance conflict in the DRC or adjoining countries. Intel processors manufactured before January 1, 2013 are not confirmed conflict free. The conflict free designation refers only to product manufactured after that date. For Intel Boxed Processors, the conflict free designation refers to the processor only, not to any additional included accessories, such as heatsinks/coolers.

See <http://www.intel.com/content/www/us/en/architecture-and-technology/hyper-threading/hyper-threading-technology.html?wapkw=hyper+threading> for more information including details on which processors support Intel® HT Technology.

Max Turbo Frequency refers to the maximum single-core processor frequency that can be achieved with Intel® Turbo Boost Technology. See www.intel.com/technology/turboboost/ for more information.

The Recommended Customer Price ("RCP") is pricing guidance for Intel products. Prices are for direct Intel customers, typically represent 1,000-unit purchase quantities, and are subject to change without notice. Taxes and shipping, etc. not included. Prices may vary for other package types and shipment quantities, and special promotional arrangements may apply. If sold in bulk, price represents individual unit. Listing of these RCP does not constitute a formal pricing offer from Intel. Please work with your appropriate Intel representative to obtain a formal price quotation.

System and Maximum TDP is based on worst case scenarios. Actual TDP may be lower if not all I/Os for chipsets are used.

Low Halogen: Applies only to brominated and chlorinated flame retardants (BFRs/CFRs) and PVC in the final product. Intel components as well as purchased components on the finished assembly meet JS-709 requirements, and the PCB / substrate meet IEC 61249-2-21 requirements. The replacement of halogenated flame retardants and/or PVC may not be better for the environment.

For benchmarking data see <http://www.intel.com/performance>.

Intel processor numbers are not a measure of performance. Processor numbers differentiate features within each processor family, not across different processor families. See <http://www.intel.com/content/www/us/en/processors/processor-numbers.html> for details.

Processors that support 64-bit computing on Intel® architecture require an Intel 64 architecture-enabled BIOS.

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for [intel](#) manufacturer:

Other Similar products are found below :

[JL82598EB S LJBR](#) [CP80617004119AES LBU3](#) [LW80603003240AAS LC39](#) [CT80618003201ABS LJ38](#) [FH8065802064011S R26H](#)
[R1304RPOSHBN](#) [12200BS23MM](#) [AT80612003090AAS LBWJ](#) [AXXCBL875HDHD](#) [NU3210MC S LJEF](#) [P82510](#) [PBA31309V1.00 S LK64](#)
[EXPI9400PF](#) [FH8065301619509S R1SJ](#) [FH8065801618304S R23V](#) [CL8064701575100SR1H1](#) [CM8063401376501S R1B0](#)
[CM8063501287304S R19W](#) [CM8063501287602S R19Y](#) [CM8063501374802S R1A5](#) [CM8063501375101S R1A8](#) [CM8064601483644S R1PK](#)
[CM8064601560113S R1QF](#) [CM8066201920404S R2L6](#) [CW8064701486802S R1HC](#) [403708R](#) [AT80571PH0772MLS LGUH](#)
[AXXCBL650HDHD](#) [BD82QM67 S LJ4M](#) [I350F2BLK](#) [IOTGTWY.DK300](#) [D8086-2](#) [E10G42BTDAG1P5](#) [CM8062100854905S R0LX](#)
[CM8063401294008S R1AV](#) [CM8063401376602S R1B1](#) [CM8063501374901S R1A6](#) [CM8064601483405S R1CN](#) [CM8064601560615S R1QJ](#)
[CM8066201919901 SR2L0](#) [CM8066201938802S R2LU](#) [CP80617004122AGS LBVT](#) [CM8064601466003S R14P](#) [CM8063501293200S R1A0](#)
[CM80616003060AES LBTD](#) [CT80618005844AAS LJ32](#) [JL82599EN S R1ZS](#) [AT80574JJ053NS LBBS](#) [FF8062700853304S R02U](#)
[FH8065802063212S R268](#)